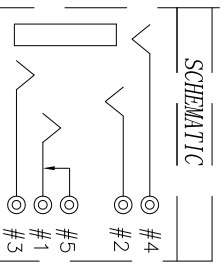
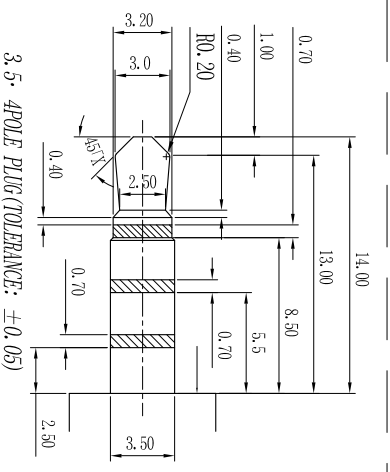


REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PRODUCT'S RELEASE	ARES	2011.01.13
B	ECN:C110145 Improving Intensity	Longjiang	2011.06.21
C	ECN:C110220 Modify body	Longjiang	2011.07.28

**SPECIFICATIONS:**

- ELECTRICAL CHARACTERISTICS:
  - 1-1. RATING: 12V 1A
  - 1-2. CONTACT RESISTANCE: 30m MAX(BEFORE)
  - 1-3. DIELECTRIC VOLTAGE WITHSTAND: 500V AC FOR ONE MINUTE
  - 1-4. INSULATION RESISTANCE: 100M MIN. MEASURED BY 500 VDC
- MECHANICAL CHARACTERISTICS:
  - 2-1. INSERTED FORCE : 3.0 KGF MAX.
  - 2-2. WITHDRAWAL FORCE : 0.3-3.0 KGF
- LIFE TEST: 5,000 CYCLES MIN.
- TO CONFORM TO THE SINGATON HSP SPECIFICATION.
- FOR BELOW SOLDERING LEAD-FREE PROCESS.
- HALOGEN FREE PRODUCT IDENTIFICATION MARK:
- HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:
- PACKAGING: TAPE & REEL.

RECOMMENDED P.C.B. LAYOUT  
TOP VIEW (TOLERANCE: ±0.05)



F	RING-B	1	COPPER ALLOY 0.2T	GOLD FLASH
E <td>EARTH</td> <td>1</td> <td>COPPER ALLOY 0.15T</td> <td>SILVER PLATED</td>	EARTH	1	COPPER ALLOY 0.15T	SILVER PLATED
D <td>RING-A</td> <td>1</td> <td>COPPER ALLOY 0.2T</td> <td>GOLD FLASH</td>	RING-A	1	COPPER ALLOY 0.2T	GOLD FLASH
C <td>TIP</td> <td>1</td> <td>COPPER ALLOY 0.2T</td> <td>GOLD FLASH</td>	TIP	1	COPPER ALLOY 0.2T	GOLD FLASH
B <td>SHUNT</td> <td>1</td> <td>COPPER ALLOY 0.2T</td> <td>GOLD FLASH</td>	SHUNT	1	COPPER ALLOY 0.2T	GOLD FLASH
A <td>BODY</td> <td>1</td> <td>HI-TEMP THERMOPLASTIC</td> <td>BLACK</td>	BODY	1	HI-TEMP THERMOPLASTIC	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES

Singaton Enterprise Co., Ltd.  
信音企業股份有限公司

DECIMALS:	ANGLES:	TITLE
X : ±0.5 X.X : ±0.3 X.XX : ±0.2	X : ±2° X.X : ±1°	<b>3.5Ø PHONE JACK</b>
PART NO. 2SJ2321-003111F		
SCALE 3:1		
SIZE: A3		
SHEET: 10/1		
REV: C		
CUSTOMER COPY		